

PATENTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re application of

Peter SATTLER et al.

Serial No. 10/041,627

GROUP 1722

Filed January 10, 2002

Examiner Unassigned

INJECTION MOULDING DEVICE COMPRISING VALVE PIN POSITION INDICATOR.

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents

Washington, D.C. 20231

Sir:

In compliance with Rules 1.97 and 1.98, and in fulfillment of the duty of disclosure under Rule 1.56, the accompanying documents, copies of which are attached to this statement, are made of record on the enclosed sheet.

A concise explanation of the relevance of these items is that these references were cited by the European Patent Office in the corresponding European application Serial No. 01 20 0060, filed January 10, 2001. A copy of the European Search Report in which they were cited is attached hereto.

Respectfully submitted,

YOUNG & THOMPSON

By

Robert J. Patch  
Attorney for Applicant

FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

APR 10 2002

ATTY. DOCKET NO.  
2001-1007SERIAL NO.  
10/041,627**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

(Use several sheets if necessary)

37 CFR 1.98(b)

APPLICANT  
Peter SATTLER et al.FILING DATE  
January 10, 2002GROUP  
1722**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL	PATENT NUMBER	ISSUE DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
AA	5,541,881	07/96	Donnell, Jr.			
AB	3,970,034	07/76	Kirk			
AC						
AD						
AE						
AF						
AG						
AH						

SEP 26 2003  
TC 1700

RECEIVED

**FOREIGN PATENT OR PUBLISHED FOREIGN PATENT APPLICATION**

	DOCUMENT NO.	PUBL. DATE	COUNTRY OR PATENT OFFICE	CLASS	SUB CLASS	TRANSLATION YES NO
AJ	38 33 220 A1	04/90	DE			
AK	A 4-112020	04/92	JP			with English abstract
AL	0 936 048 A1	08/99	EP			
AM	00/71325 A1	11/00	WO			
AN	1140 110	11/62	DE			
AO	0 269 091	06/88	EP			
AP						

RECEIVED

APR 15 2002

TC 1700

**OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)**

AT	David Kazmer, "Multi-Cavity Pressure Control in the Filling and Packing Stages of the Injection Molding Process," Polymer Engineering and Science, V. 37, 1997, pp. 1865-1879.
----	--

**EXAMINER****DATE CONSIDERED**

**EXAMINER:** Initial citation considered. Draw line through citation if not in conformance and not considered.  
Include copy of this form with next communication to applicant.